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Atty. Dkt. No. APPM/008670/DSM/LOW K/JW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Li, et al.

Serial No.: 10/801,190

Confirmation No.: 1633

Filed:

March 15, 2004

For:

Adhesion Improvement for

Low K Dielectrics

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Group Art Unit: 2891

Examiner:

Granvill D. Lee

MAIL STOP AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on August 30, 2005 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 30, 2005

Date

Brian K. Hrna

RESPONSE TO OFFICE ACTION DATED JUNE 3, 2005

In response to the Office Action dated June 3, 2005, having a shortened statutory period for response set to expire on September 3, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/008670/BKH, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. Remarks begin on page 7 of this paper.